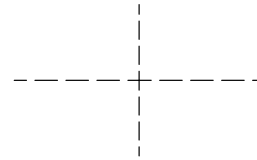
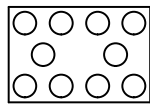
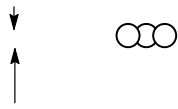
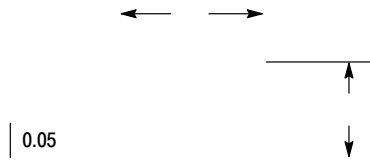


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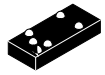
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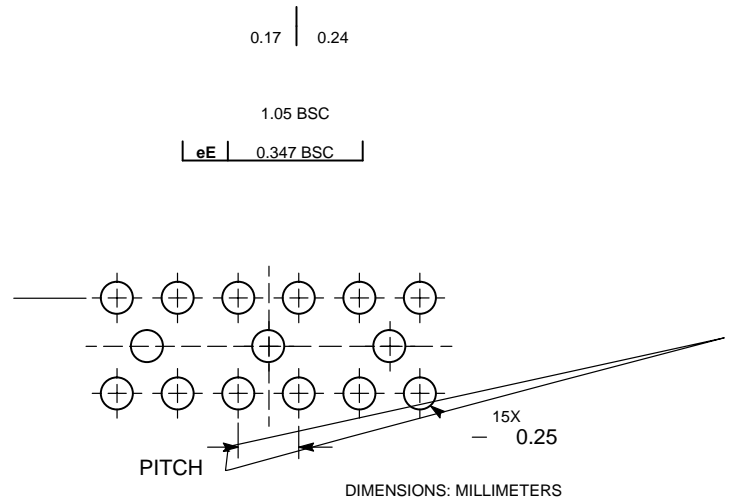
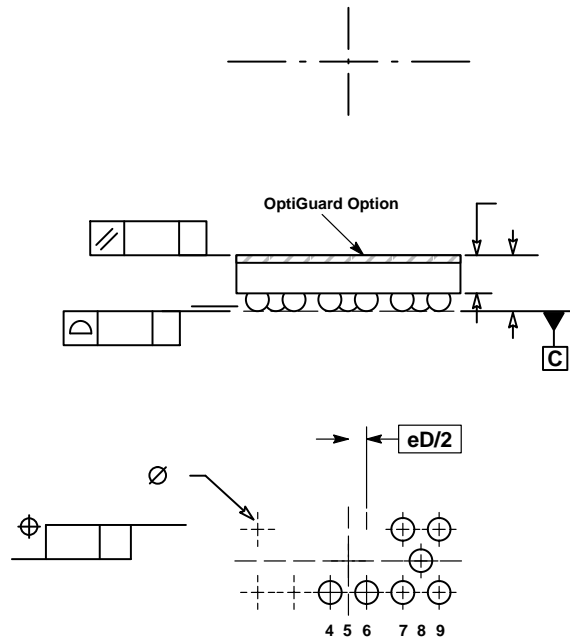


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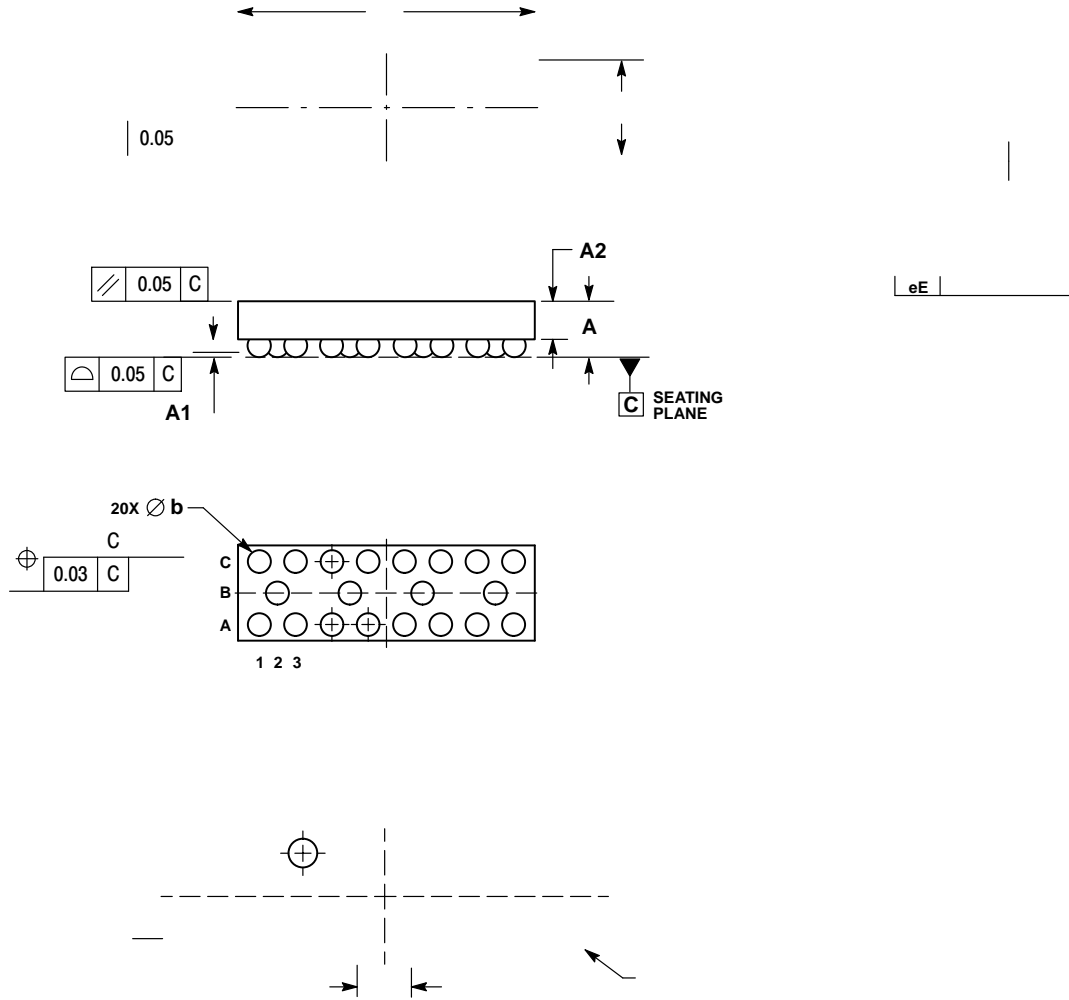
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*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

WLCSP20, 3.27x1.05

SCALE 4:1



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